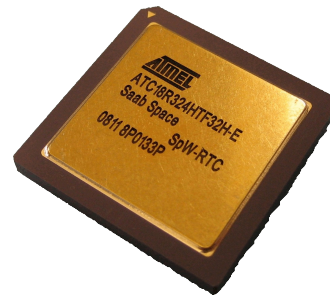


SpaceWire

Remote Terminal Controller

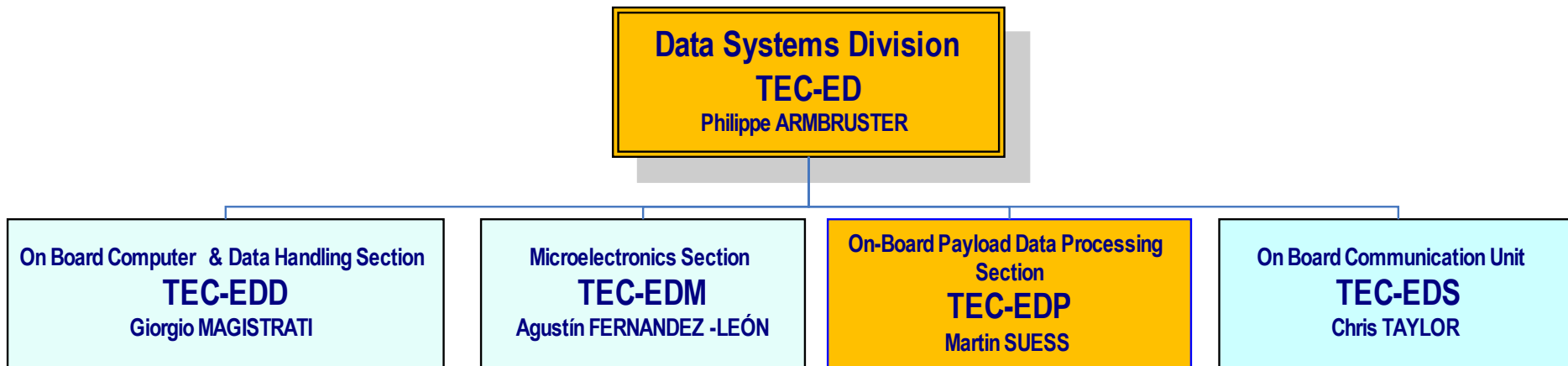
AT7913E



J. Ilstad

Onboard Payload Data Processing section (TEC-EDP)

ESA/ESTEC

TEC-ED: Sections and associationResponsibilities:

Technical Officer SpW-RTC Development
Support to payload processing developments
Project support to ongoing missions
SpaceWire Components Support

Overview

- **Introduction**
- **ESA Strategy for Payload Developments**
- **SpW-RTC Description**
- **SpW-RTC and Onboard Data Handling**
 - **Application Areas**
- **Performances**
- **SpW-RTC Development Suites**
- **Usage in Missions**
- **Status and Availability**

ESA strategy for payload developments

- Development of **Application Specific Standard Products (ASSP)**
 - Devices capable of answering most onboard computing needs for the coming decade.
- Adopt upcoming ASIC developments to use **similar device architectures** based on **pre-validated ESA IP cores** for the purpose of reducing development time and recurring costs.
- Ensure SpW nodes developed by ESA to be **easily integrated** in ESA On-Board Distributed Computing and Control System.

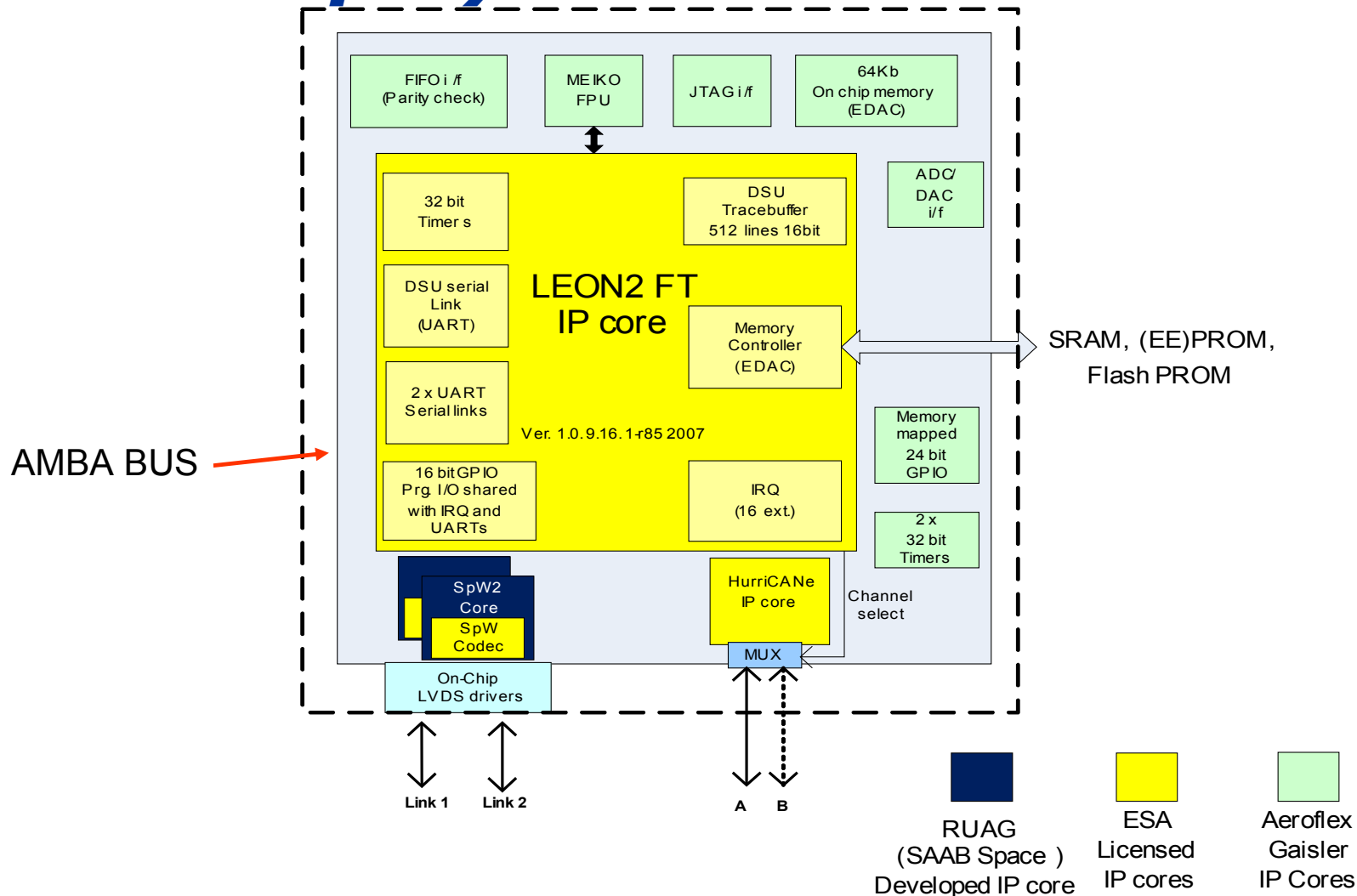
SpW-RTC Description

Device

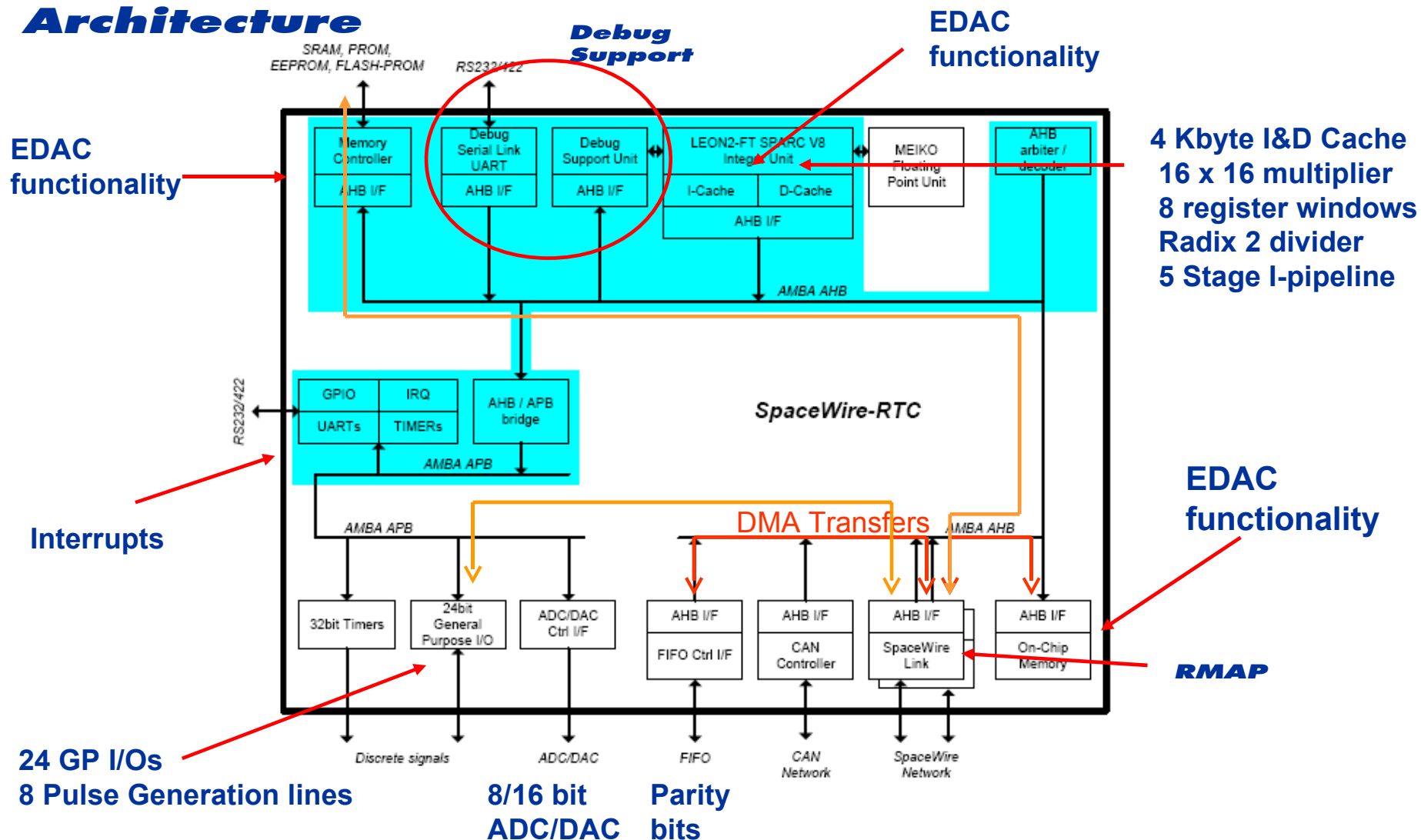
- SpW Remote Terminal Controller contains
 - **Leon2 FT and FPU**,
 - CAN-Bus (N&R selectable)
 - 2*SpW,
 - SRAM, FIFO, ADC, DAC, UART, Parallel etc. interfaces
- SpW link speeds 200MBit/s
- System-on-Chip for compact RT implementation
- SW can be uploaded via SpW link (RMAP compatible)
- Direct Memory and IO Access via SpW RMAP
- LGA 349
- Power consumption: **~0.7W@50MHz**
- **1.8V** core, **3.3V** I/O
- RT CMOS Technology: **ATC18RHA** (0,18 μm)



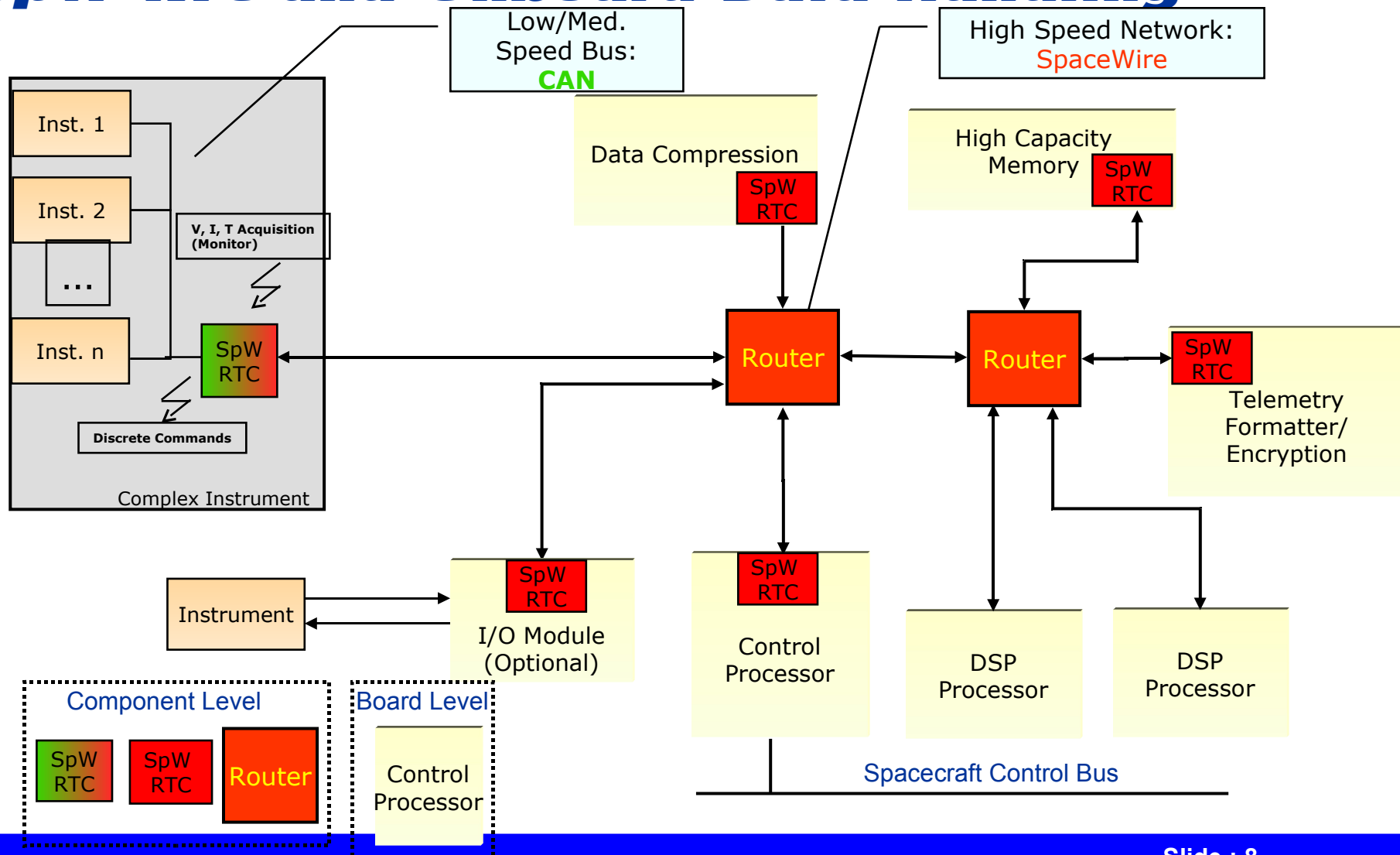
System on Chip Layout



Architecture



SpW-RTC and Onboard Data Handling



Performances; CPU

The SpW-RTC ASIC processor performance (@ 50MHz)

- **Dhrystone 2.1 benchmark**
 - 34,4 MIPS
- **Stanford benchmark**
 - 91 integer composite
 - 138 float composite
- **GNC benchmark**
(68,6 million instructions, 16.6% present FP instructions):
 - 2,4 MFLOPS

Performances; Application Example

- Description of application:
 - executes **Dhrystone benchmark** via of chip SRAM
 - data transfers from **on-chip memory via loop backed SpaceWire links** (full duplex)
 - data transfers from **on-chip memory to external FIFO and back again**
 - 12bit value to **DAC** and read back via **ADC** interface
 - **GPIO pulse generation**
 - **CAN bus traffic** to external test equipment

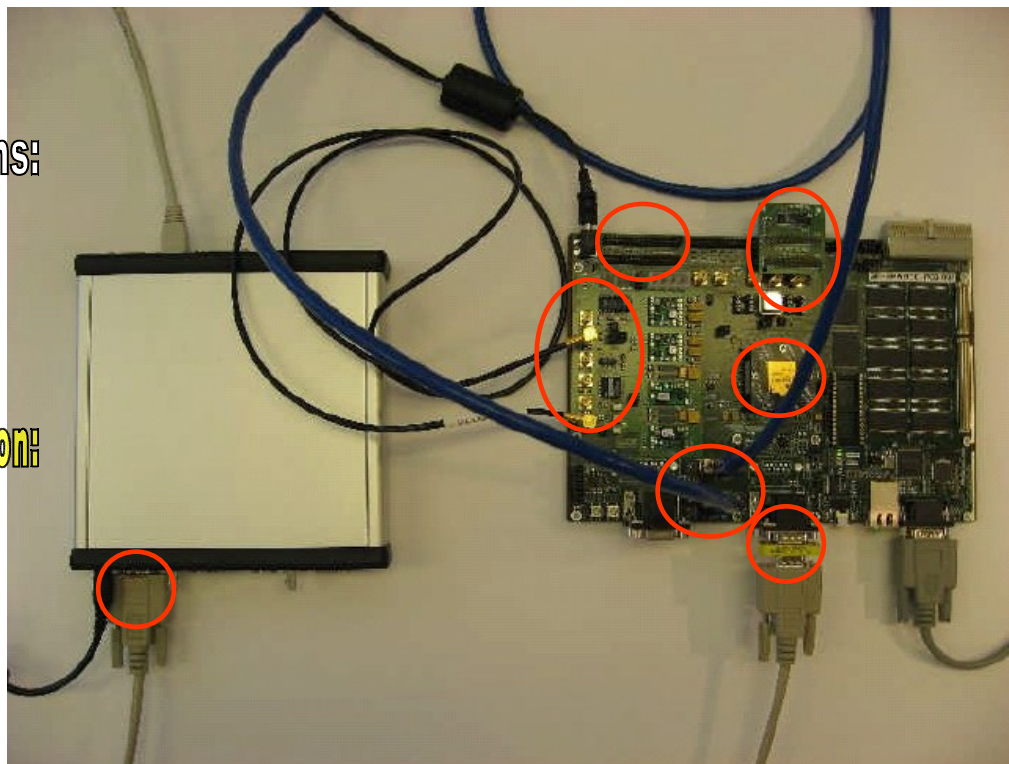
European General Purpose Microprocessors

Performances; Application Example

GPIO Pulse generation:
784 per second

DAC/ADC conversions:
784 per second

ASIC Power Consumption:
342mW (1.8V Core)
230mW (3.3V I/O)
11.44 mW/MHz



FIFO throughput:
295 Mbit/s, 1,35 clock per byte

Dhrystone Benchmark
27.9 MIPS
(compared to 34.4 MIPS)

CAN communication:
208 kbit/sec

SpaceWire loopback:
587 Mbit/s (full duplex)

SpW-RTC Development Suites

Aeroflex Gaisler Products



Hardware

- ASIC Development board with housing and power supply
 - SpW-RTC prototype ASIC
 - RTEMS drivers for SpaceWire, CAN and FIFO
 - GRMON debug monitor

Software

- Bare-C compilation system (BCC)
- RTEMS – drivers and BSP
- Wind River VxWorks – drivers and BSP (sold separately)

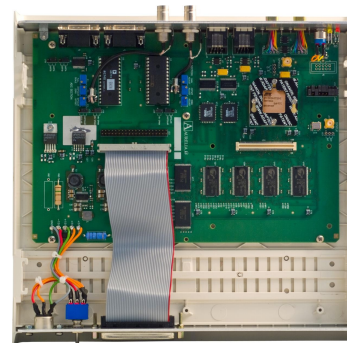
Additional Tools

- GRESB – Ethernet SpaceWire bridge w. IP tunnel
- GRMON – debug monitor (debugging over RMAP)
- TSIM2 – instruction simulator with SpW-RTC loadable module



SpW-RTC Development Suites**CAEN Aerospace / Aurelia Microelettronica Products****Hardware**

- A1493A PCI-SpW/CAN
- A1494 RTC Test-Bed

**Software**

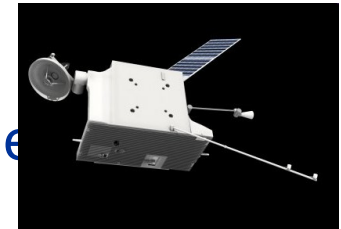
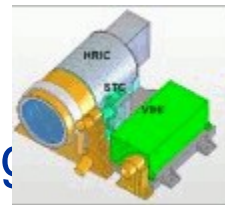
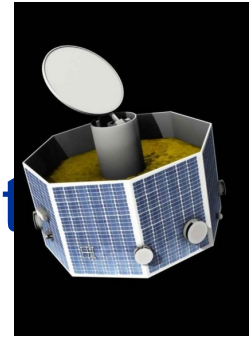
- Linux based GUI control application.
- Uses SpaceWire RMAP to control, program and debug the SpW-RTC chip.

Tools

- Compatible with GRMON tool which can be obtained from Aeroflex Gaisler

Usage in Missions

- Implemented in Bepi Colombo instrument
 - MERMAG
 - Magnetometer
 - SIMBO-SYS
 - Spectrometer and Image integrated package
- Solar Orbiter
 - Base lined for several instruments to form a common payload interface.



Status and Availability

- Prototypes available W7 2009 (**done**)
- Prototype approval foreseen W12 2009 (**done**)
- AT7913E Atmel Standard Product (Q4 2009)
- Availability: EMs (early Q1 2010), FMs (Q3 2010)